duson	Document Number 001	DOC – Wifi Module Installation Guide	
- 3	Revision	006	

### **DYSON CONFIDENTIAL INFORMATION**

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## 1. Installation of the Radio Module

The device WIFIAMFA001 is only used in Dyson products. This module is factory mounted in the Dyson Environmental Products.

This module is not supplied to the end user on its own and the WIFIAMFA001 module will only be installed or replace on the end products by Dyson Engineers. As such a simple installation guide is given for reference only.

# 2. Compliance Statement

### FCC (Federal Communications Commission) statements

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: 1) The device may not cause harmful interference, and

2) The device Module must accept any interference received, including interference that may cause undesired operation.

This device complies with FCC RF radiation exposure limits set forth for an uncontrolled environment. The antenna used for this transmitter must be installed to provide a separation distance of at least 20 cm from all persons and must not be co-located or operating in conjunction with any other antenna or transmitter.

Important Note: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation.

This transmitter must not be co-located or operating in conjunction with any other antennas or transmitters.

It is the responsibility of the host device manufacturer to ensure continued compliance with FCC rule part 15B once the module has been installed in the host device.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

The concerned end product must be labelled to say "Contains FCC ID: **QVHWIFIAMFA001"** 

#### **Industry Canada statements**

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions:

1) The device may not cause interference, and

2) The device must accept any interference, including interference that may cause undesired operation of the device.

Important note: To comply with Industry Canada RF exposure limits, the antenna used for this device must be installed to provide a separation distance of at least 20cm from all persons. RF exposure is in accordance with RSS-102, section 2.5.2.

The concerned end product must be labelled to say "Contains IC: **7986A-WIFIAMFA001**"



Declarations d'Industry Canada

Cet equipement est conforme aux normes d'exemption de licence RSS d'Industry Canada. Son utilisation est soumise aux deux conditions suivantes:

1) Le dispositif ne doit pas provoquer d'interference, et

2) Le dispositif doit accepter toute interference, y compris des interferences susceptibles de provoquer un fonctionnement indesirable de l'equipement.

Remarque importante: Pour respecter les limites d'exposition aux radiofrequences d'Industry Canada, l'antenne utilisée pour cet appareil doit être installé pour fournir une distance de séparation d'au moins 20 cm de toutes les personnes.

L'exposition aux RF est conforme à la norme RSS-102, section 2.5.2.

Le produit final concerne doit porter une etiquette avec la mention:

"Contient IC: 7986A-WIFIAMFA 001"

## 3. Antenna Configuration & Specification

The antenna is a double sided PCB printed monopole. It is L-shape on top side and Inverted F IFA on the other side as shown in the Figures 1, 2 below.

Antenna Specification			
Туре	PCB Printed Antenna		
Frequency range	2.4 to 2.5GHz		
Maximum Gain	2.08dBi		
Impedance	50 ohm		
VSWR	≤ 2:1		

The maximum isotropic antenna gain the Radio module measured in UL OTA chamber is 2.08dBi @ 2.46GHz

Frequency	Efficiency in %	Efficiency in dB	Maximum Gain in dBi	
240000000	81%	-0.92	1.82	
2420000000	80%	-0.96	1.69	
2440000000	84%	-0.77	1.84	
2460000000	87%	-0.58	2.08	
2480000000	86%	-0.63	1.91	
250000000	88%	-0.57	1.94	

#### 3D Antenna Pattern



duson	Document Number 001	DOC – Wifi Module Installation Guide
- 9	Revision	006

The antenna is a double sided PCB printed monopole. It is L-shape on top side and Inverted F IFA on the other side as shown in the Figures 1, 2 below.

The antenna is printed on PCB carrier board 35mm x 35mm x 1.6mm and 4.2 FR4. The wifi module is mounted on the same board.



Figure1, PCB Printed antenna Top Side



Figure2, PCB Printed antenna Bottom Side



# 4. Bare Board Specification

### 4.1. Bare Board Processing

Parameter	Value
Material Type:	RF-4
RoHS Compliance	Required
Nominal board thickness	1.6mm
Board Finish	Immersion Gold (ENIG)
Layers	4
Copper Thickness (Finished) Outer	35um
Copper Thickness (Finished) Inner	N/A
Conformal Coating required	Yes
UL Release	N/A
Solder Mask	Photo Imageable
Solder Mask Colour	Green
Peelable Mask	N/A
Silkscreen required (Top / Bottom / Both Sides)	Тор
Silkscreen Colour	White
Panelisation (V-Score / Rout / None)	Routed

### 4.2. PCB Stack

Layer Name	Thickness (mm)	Material
TOP COPPER	0.0436	COPPER FOIL 17/0
FR4	0.185	PREPREG 7628MR
FR4	0.185	PREPREG 7628MR
COPPER LAYER 2	0.035	
FR4	0.70	0.70 COPPER FOIL 35/35
COPPER LAYER 3	0.035	
FR4	0.185	PREPREG 7628MR
FR4	0.185	PREPREG 7628MR
BOTTOM COPPER	0.0436	COPPER FOIL 17/0



### 4.3. PCB Guidelines:

- 1. Ground via holes must be located close to module ground pads.
- 2. Signal traces must not run underneath the module on the layer where the module is mounted.
- 3. Have a complete ground pour in layer 2 for thermal dissipation.
- 4. Have a solid ground plane and ground via holes under the module for stable system and thermal dissipation.
- 5. Increase the ground pour in the first layer and have all of the traces from the first layer on the inner layers, if possible.
- 6. Signal traces can be run on a third layer under the solid ground layer, which is below the module mounting layer.
- 7. Power traces can be run on a third layer. Use ground to insulate signal traces from power. Use thick traces for power.
- 8. Use lots of ground stitches around the RF transmission line (0.5mm pitch)
- RF transmission line is 50Ω grounded CPW with dimensions calculated using 'AWR txline 2003'. Dimensions calculated using the PCB stack detailed in Section 4.2 using Er 4.2, dielectric height from layer 1 to layer 2 of 0.37mm and trace plating thickness of 0.043mm. Width(W) = 0.55mm, Gap(G) = 0.23mm, Height(H)=0.37mm.

🔊 TXLINE 2003 - CPW						
Microstrip Stripline C	PW CPW Ground	Round Coaxial	Slotline	Coupled MSLine Cou	pled Stripline	
Material Parameters						
Dielectric GaAs	_	Conductor	Silver	<u> </u>	] _ +G	+ +W+  ↓
Dielectric Constant	4.2	Conductivity	5.88E+07	S/m 💌	] <mark>_</mark> _	ε. Τ
Loss Tangent	0.001			AWR	]   🛁	
Electrical Characteristi	CS		1	Physical Characteris	tic	
<u>Impedance</u>	50.23	Ohms 💌		Physical Length (L)	3	mm 💌
Frequency	2.5	GHz 💌		Width (W)	0.55	mm 💌
Electrical Length	14.875	deg 💌		Gap (G)	0.23	mm 💌
Phase Constant	4958.33	deg/m 💌		Height (H)	0.37	mm 💌
Effective Diel. Const.	2.72789			Thickness (T)	0.043	mm 💌
Loss	2.19905	dB/m ▼				
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- 10. Lots of stitches for ground in general
- 11. Lots of ground stitches around the board
- 12. No signal or power traces running on the edge of the board.